

Call for Papers

IEEE Transactions on Plasma Science Special Issue for Selected Papers from EAPPC/BEAMS/EML 2026

The IEEE Transactions on Plasma Science invites all attendees of the 11th Euro-Asian Pulsed Power Conference (EAPPC 2026), the 26th International Conference on High-Power Particle Beams (BEAMS 2026) and the 21st International Symposium on Electromagnetic Launch Technology (EML 2026) to submit your manuscripts to a Special Issue dedicated to this joint conference. The objective of this Special Issue is to provide the widest possible distribution of archival quality papers detailing up-to-date developments reported at EAPPC/BEAMS/EML 2026. Contributions to the Special Issue will undergo the same rigorous review standards as typical for all IEEE Transactions and Journals.

IEEE policy requires that a manuscript submitted to the Special Issue must be significantly revised and lengthened from that published on the conference proceedings. Every submission to the Special Issue will undergo an automatic plagiarism check by comparing with articles previous published elsewhere.

This Special Issue is open to, but not limited to, all attendees of EAPPC/BEAMS/EML 2026. The IEEE Author Portal at

<https://iee.atyponrex.com/journal/tps-ieee>

will be used for electronic manuscript submission. Papers should be submitted to the website no later than **December 31, 2026** in order to complete the review process in time for the October 2027 publication date.

Authors may seek additional information by contacting any one of the following Guest Editors.

Dr. Anton Gusev
Université de Pau et des
Pays de l'Adour (UPPA)
Av. de l'Université
64000 Pau
France
anton.gusev@univ-pau.fr

Dr. Markus Schneider
French-German Research
Institute of Saint-Louis
68300 Saint-Louis
France
markus.schneider@isl.eu

Dr. Taichi Sugai
Extreme Energy-Density
Research Institute
Nagaoka University of
Technology
Nagaoka, Niigata
940-2188
Japan
t_sugai@nagaokaut.ac.jp

Dr. Liang Yu
State Key Laboratory for
Power Transmission
Equipment Technology
Chongqing University
Shapingba, Chongqing
400044
China
yu_liang@cqu.edu.cn

